Vishay Semiconductors

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Hyperfast Rectifier, 30 A FRED Pt[®]



PRIMARY CHARACTERISTICS					
I _{F(AV)}	30 A				
V _R	650 V				
V _F at I _F at 125 °C	1.6 V				
t _{rr}	27 ns				
T _J max.	175 °C				
Package	TO-220AC 2L				
Circuit configuration	Single				

FEATURES

- · Hyper fast and soft recovery time
- Low forward voltage drop
- 175 °C maximum operating junction temperature
- · Low leakage current
- True 2 pin package
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

Ultra low V_F, soft-switching hyper fast rectifiers optimized for discontinuous (critical) mode (DCM) power factor correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	V _{RRM}		650	V			
Average rectified forward current	I _{F(AV)}	T _C = 120 °C	30	٨			
Non-repetitive peak surge current	I _{FSM}	T _C = 25 °C	210	A			
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C			

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	L TEST CONDITIONS		TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 250 μA	650	-	-		
Forward voltage	V _F	I _F = 30 A	-	2.1	2.5		
Forward voltage		I _F = 30 A, T _J = 125 °C	-	1.6	1.7		
Reverse leakage current	I _R	$V_{R} = V_{R}$ rated	-	0.02	30		
neverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	50	300	μA	
Junction capacitance	CT	V _R = 200 V	-	22	-	pF	
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	8.0	-	nH	

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time	t _{rr}	T _J = 25 °C	$I_F = 1 A$ $dI_F/dt = 100 A/\mu s$ $V_R = 30 V$	-	35	-	. ns
	-11	T _J = 25 °C		-	27	-	
		T _J = 125 °C	I _F = 30 A dI _F /dt = 1000 A/μs V _B = 400 V	-	88	-	
Peak recovery current	I _{RRM}	T _J = 25 °C		-	15	-	A
		T _J = 125 °C		-	24	-	
	_	T _J = 25 °C	VK - 700 V	-	330	-	nC
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	1350	-	nc

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R _{thJC}		-	1.0	1.3		
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	70	°C/W	
Thermal resistance, case to heat sink	R _{thCS}	Mounting surface, flat, smooth, and greased	-	-	0.5		
Weight			-	0.2	-	g	
weight			-	0.07	-	oz.	
Mounting torgue			6.0		12	kgf · cm	
			(5.0)	-	(10)	(lbf \cdot in)	
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C	
Marking device		Case style: TO-220AC 2L	ETX3007				

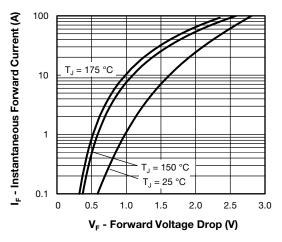


Fig. 1 - Typical Forward Voltage Drop Characteristics

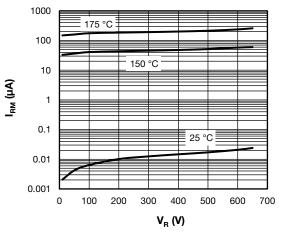


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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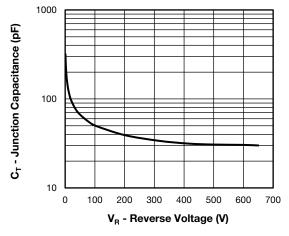


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

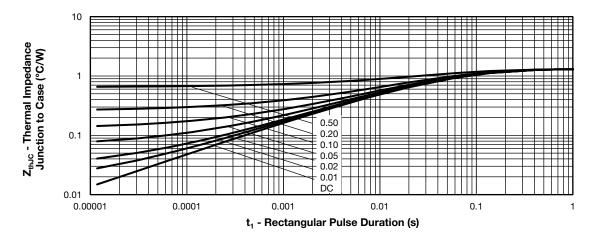
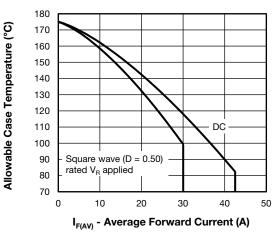


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

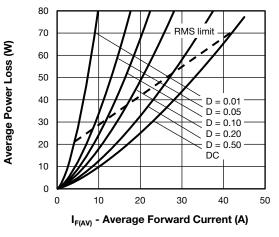


Fig. 6 - Forward Power Loss Characteristics

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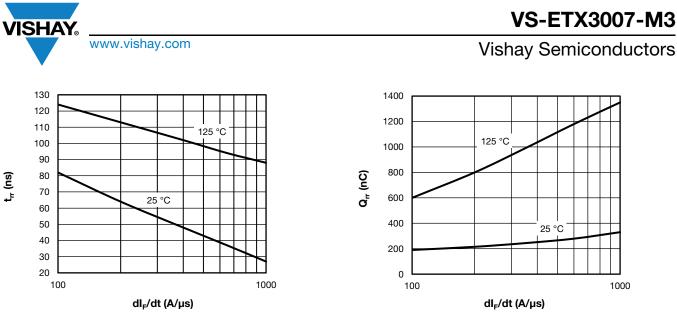
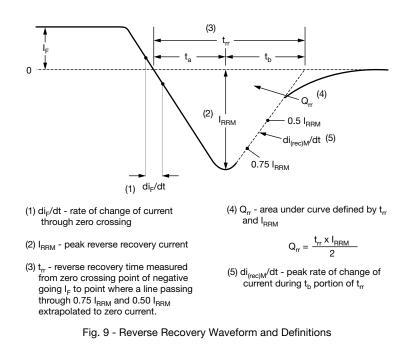


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Fig. 8 - Typical Reverse Recovery Time vs. dl_F/dt



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ORDERING INFORMATION TABLE

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SHAY

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Device code	VS-	E	Т	X	30	07	-M3	
	1	2	3	4	5	6	7	
	1	- Visl	nay Sem	niconduo	ctors pro	oduct		
	2	- E=	single o	diode				
	3	- Pac	kage:					
		T =	TO-220	AC				
	4	- X=	hyper fa	ast reco	very			
	5	- Cur	rent rati	ng (30 =	= 30 A)			
	6	- Vol	Voltage rating (07 = 650 V)					
	7	- Env	vironmer	ntal digit				
		-M3	8 = halog	gen-free	, RoHS	-complia	ant, and	

ORDERING INFORMATION (Example)					
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION			
VS-ETX3007-M3	50	Antistatic plastic tubes			

LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?96156					
Part marking information	www.vishay.com/doc?95391				
SPICE model	www.vishay.com/doc?96532				



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